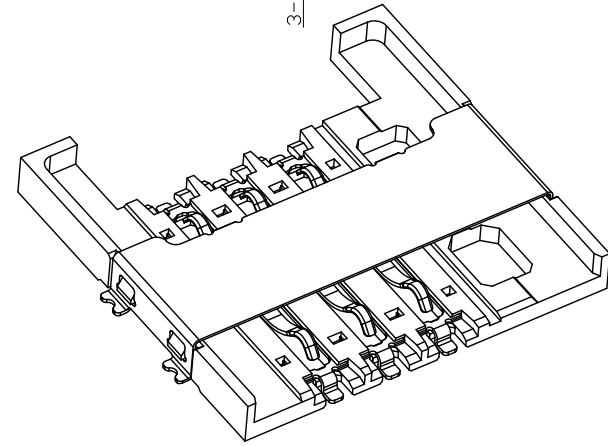
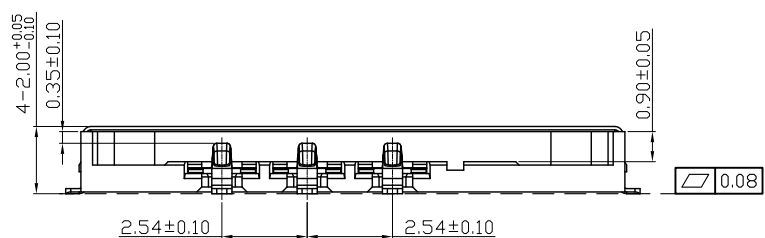
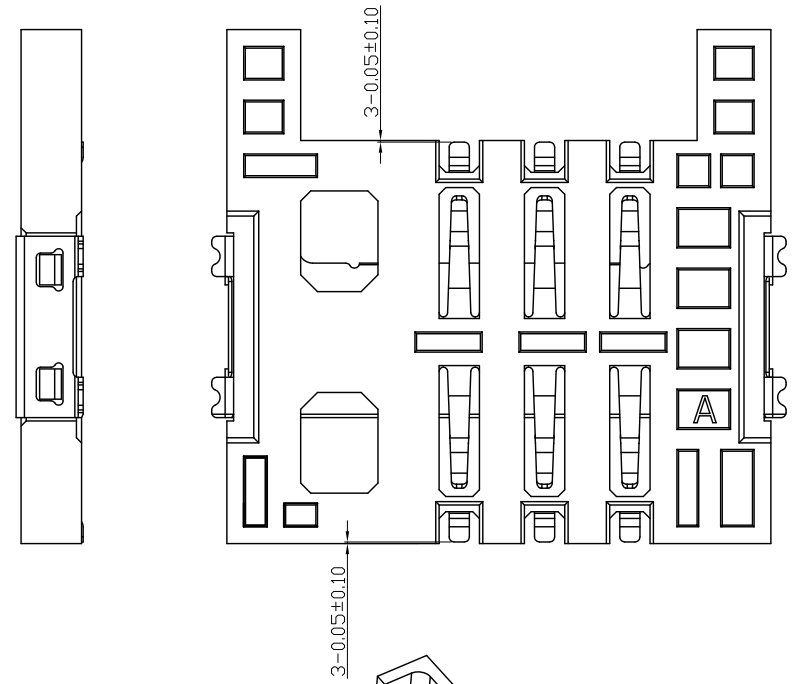
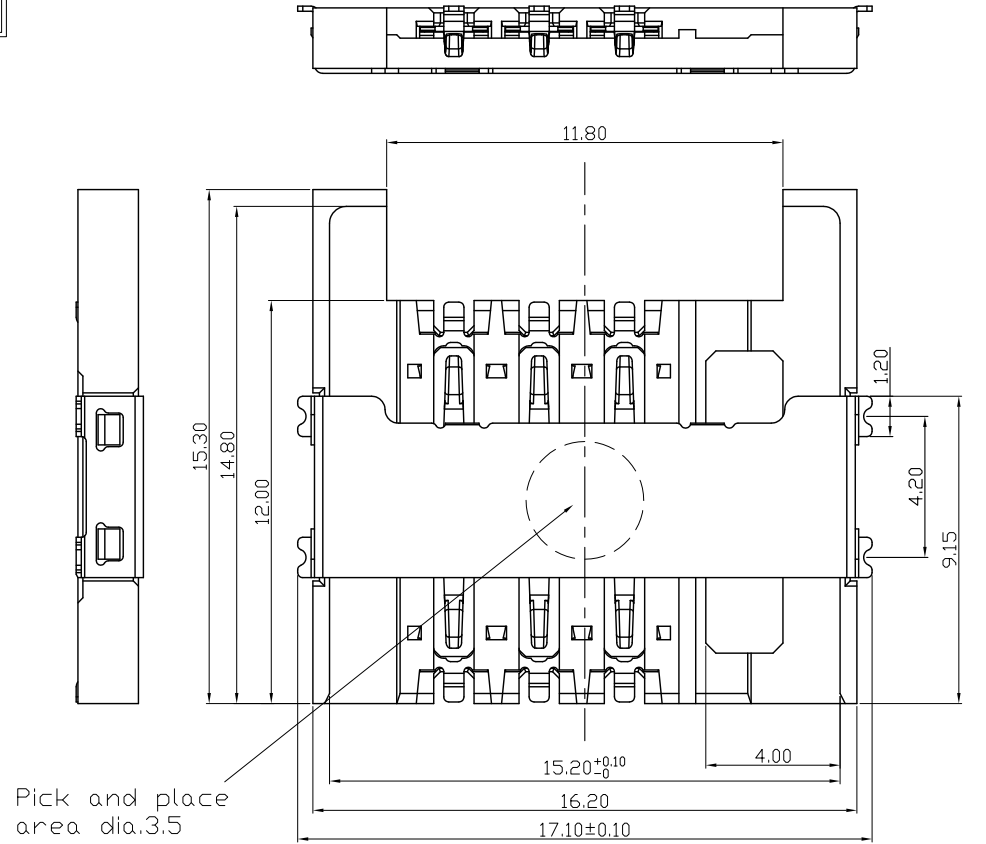


RoHS Compliant HF

REV.	ECN.NO.	MODIFY.CONTENT
A		NEW

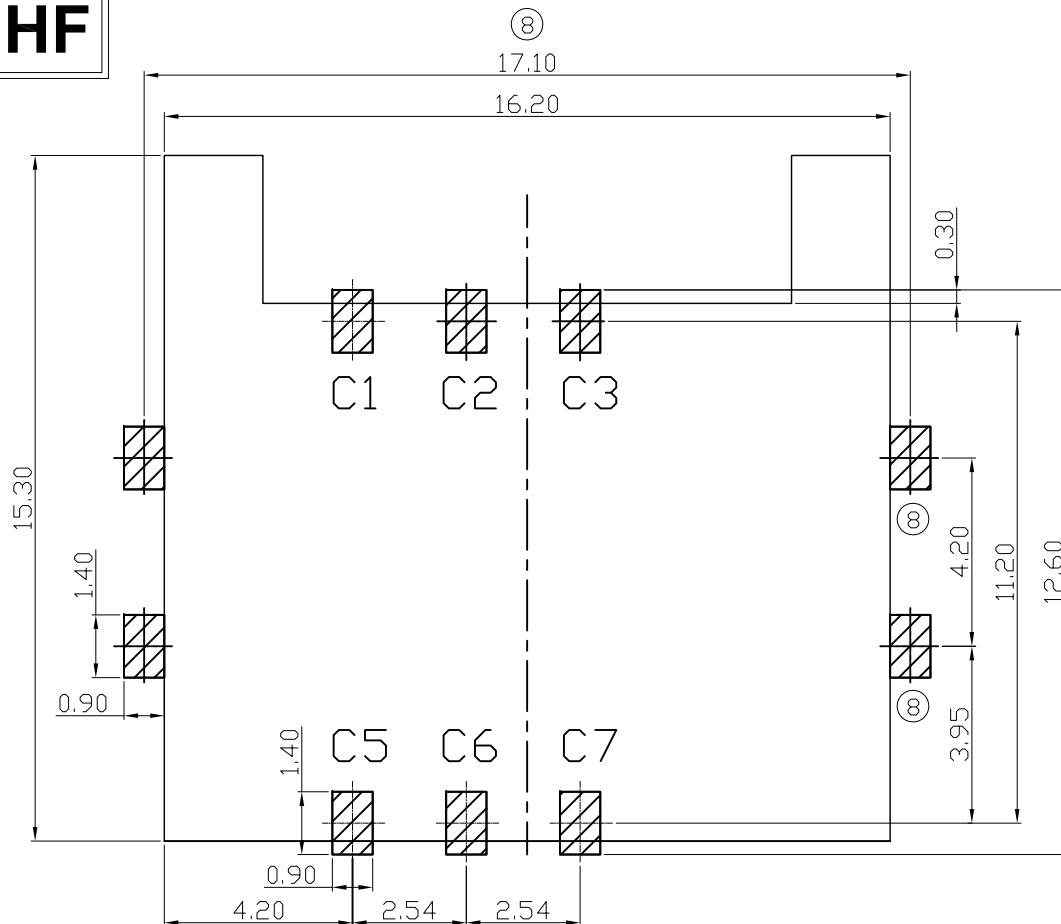


GENERAL	TOLERANCE	DWG.NO.	SP153-AN401-00	PART.NO.	SP153-AN401-**	DRAWN	L.M.J 2021.07.23
x.±0.50	x.*± 5°	REV.	A	TITLE	Sim Card No Push H2.0	CHECKED	
.x±0.25	.x*± 2°	SIZE		SHEET	1 OF 3	APPROVED	
.xx±0.15	.xx± 1°	A4					

UNIT	mm	SCALE	1:1
东莞市欧联电子科技有限公司 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			

RoHS Compliant HF

REV.	ECN.NO.	MODIFY.CONTENT
A		NEW



NOTES :

1. MATERIAL :

- 1.1 HOUSING:LCP S475 UL94 V-0, BLACK COLOR.
- 1.2 SHELL: STAINLESS STEEL SUS304.
- 1.3 CONTACT: COPPER ALLOY C5210.

2. FINISH :

- 2.1 CONTACT: GOLD PLATING ON CONTACT AREA, GOLD FLASH ON SOLDER TAIL AREA. 50u" MIN NICKEL PLATING OVERALL.
- 2.2 SHELL: 30u" MIN NICKEL PLATING OVERALL.

3. ELECTRICAL CHARACTERISTICS:

- 3.1 OPERATING VOLTAGE : 100V AC(rms)/DC.
- 3.2 CURRENT RATING : 0.5 A.
- 3.3 OPERATING TEMPERATURE: -25°C~+85°C.
- 3.4 CONTACT RESISTANCE: 100 m OHMS MAX.
- 3.5 INSULATION RESISTANCE: 1000M OHMS MIN. AT 250VDC.
- 3.6 DIELECTRIC WITHSTANDING VOLTAGE:500 VAC/1MINUTE.

PART.NO.:


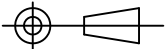
SP153-AN401-\*\*

- 08: 功能区镀金1U", 锡脚Gold Flash
- 09: 功能区镀金3U", 锡脚Gold Flash
- 10: 功能区镀金5U", 锡脚Gold Flash
- 11: 功能区镀金15U", 锡脚Gold Flash
- 12: 功能区镀金30U", 锡脚Gold Flash

RECOMMENDED PCB LAYOUT  
(NON-SOLDER MASK DEFINE PWB)  
PWB TOLERANCE: ±0.05MM

PIN ASSIGNMENTS

PIN NO.	Pin NO.
C1	VCC:PWR single and GND
C2	RST:Reset signal
C3	CLK:Clocking signal
C5	GND:PWR single and GND
C6	VPP: programming Voltage
C7	I/O:serial date input/output

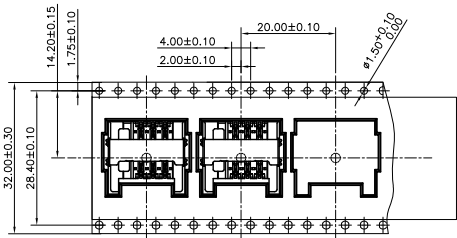
GENERAL	TOLERANCE	DWG.NO.	SP153-AN401-00	PART.NO.	SP153-AN401-**	DRAWN	L.M.J 2021.07.23	UNIT	mm	SCALE	1:1
.x±0.50	.x.± 5°	REV.	A	TITLE	Sim Card No Push H2.0	CHECKED		 东莞市欧联电子科技有限公司 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			
.x±0.25	.x.± 2°	SIZE		SHEET	2 OF 3	APPROVED					
.xx±0.15	.xx± 1°	A4									

# 东莞市欧联电子科技有限公司

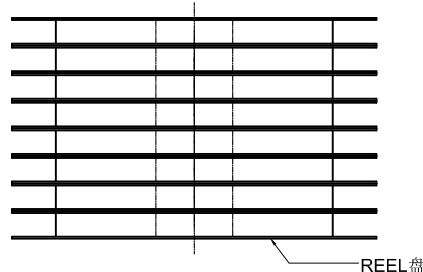
## 包装作业规范

### 包装作业图示及说明 (PACKING OPERATION DIAGRAM & INSTRUCTION)

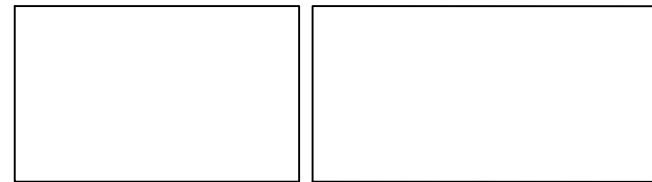
- 一.
- 1) 将成品一一放入REEL包装盘内, 依同一方向放入.
  - 2) 包装时, 如下图所示, 放置 1000 个成品.



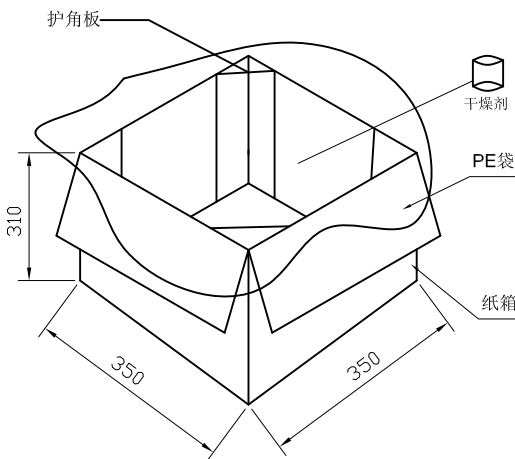
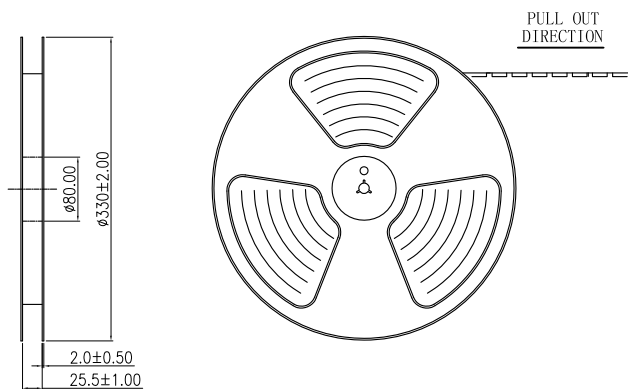
- 三.
- 1) 每箱装8盘REEL包装盘.
  - 2) 每箱放置8000PCS 的成品.



- 四.
- 1) 用TAPE将纸箱封实.



- 二.
- 1) 装盘前先把前面空15pcs产品, 然后再开始装盘, 尾端也需空出15pcs产品, 上带加长200mm.
  - 2) 装满成品的REEL包装盘如下图所示.



### 備註 (REMARK)

1. 若有未裝滿之零數箱, 必須以緩衝材塞滿.

GENERAL TOLERANCE	DWG.NO.	SP153-AN401-00	PART.NO.	SP153-AN401-**	DRAWN	L.M.J 2021.07.23
x.±0.50	REV.	A	TITLE	Sim Card No Push H2.0	CHECKED	
.x±0.25	SIZE		SHEET	3 OF 3	APPROVED	
.xx±0.15	A4					

UNIT	mm	SCALE	1:1
<b>东莞市欧联电子科技有限公司</b> DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			